

Docket No.: 4770-0103PUS1

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Daisuke UCHIDA et al.

Application No.: 10/511,143

Confirmation No.: 1981

Examiner: C. F. F. Lam

Filed: October 14, 2004

Art Unit: 1775

For: VARNISH, FORMED MATERIAL,

ELECTRICAL INSULATION FILM, MULTILAYER STRUCTURE, FLAME

RETARDANT SLURRY AND PREPARATION

PROCESS OF FLAME RETARDANT

PARTICLES AND VARNISH

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated July 26, 2006, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.